Quad single-pole single-throw analog switch Rev. 7 — 2 April 2013

Product data sheet

1. **General description**

The 74HC4066; 74HCT4066 is a quad single pole, single throw analog switch. Each switch features two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

Features and benefits 2.

- Input levels nE inputs:
 - For 74HC4066: CMOS level
 - For 74HCT4066: TTL level
- Low ON resistance:
 - 50 Ω (typical) at V_{CC} = 4.5 V
 - 45 Ω (typical) at V_{CC} = 6.0 V
 - 35 Ω (typical) at V_{CC} = 9.0 V
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

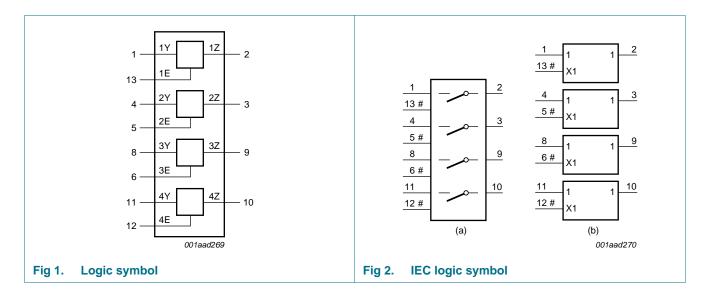


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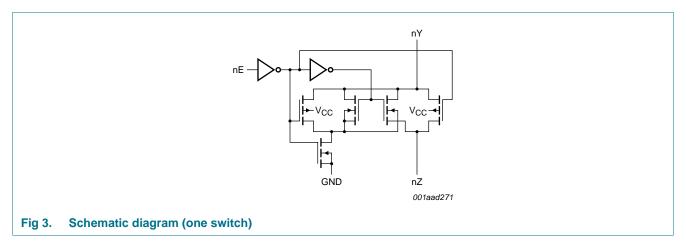
3. Ordering information

Table 1. Orde	ering information			
Type number	Package			
	Temperature range	Name	Description	Version
74HC4066N	–40 °C to +125 °C	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1
74HCT4066N				
74HC4066D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width	SOT108-1
74HCT4066D			3.9 mm	
74HC4066DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body	SOT337-1
74HCT4066DB			width 5.3 mm	
74HC4066PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body	SOT402-1
74HCT4066PW			width 4.4 mm	
74HC4066BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very	SOT762-1
74HCT4066BQ			thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	

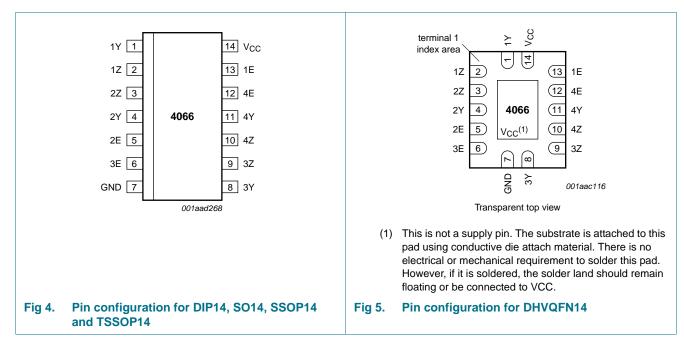
4. Functional diagram



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5. Pinning information



5.1 Pinning



Table 2. Pin description		
Symbol	Pin	Description
1Z, 2Z, 3Z, 4Z	2, 3, 9, 10	independent input or output
1Y, 2Y, 3Y, 4Y	1, 4, 8, 11	independent input or output
GND	7	ground (0 V)
1E, 2E, 3E, 4E	13, 5, 6, 12	enable input (active HIGH)
V _{CC}	14	supply voltage

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6. Functional description

Table 3.Function table^[1]

Input nE	Switch
L	OFF
Н	ON

[1] H = HIGH voltage level;

L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+11.0	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _{SK}	switch clamping current	V_{SW} < –0.5 V or V_{SW} > V_{CC} + 0.5 V	-	±20	mA
I _{SW}	switch current	V_{SW} = –0.5 V to V_{CC} + 0.5 V	<u>[1]</u> _	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-	-50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2]		
		DIP14 package		-	750
		SO14, (T)SSOP14 and DHVQFN14 packages		-	500
Р	power dissipation	per switch	-	100	mW

[1] To avoid drawing V_{CC} current out of terminal Z, when switch current flows in terminals Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{CC} current will flow out of terminals Yn. In this case there is no limit for the voltage drop across the switch, but the voltages at Yn and Z may not exceed V_{CC} or GND.

[2] For DIP14 package: P_{tot} derates linearly with 12 mW/K above 70 °C.
 For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For (T)SSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

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Recommended operating conditions 8.

Symbol	Parameter	Conditions	7	'4HC406	6	7	Unit		
			Min	Тур	Max	Min	Тур	Max	
V _{cc}	supply voltage		2.0	5.0	10.0	4.5	5.0	5.5	V
VI	input voltage		GND	-	V _{CC}	GND	-	V _{CC}	V
V _{SW}	switch voltage		GND	-	V _{CC}	GND	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
∆t/∆V	input transition rise	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
	and fall rate	$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V
		$V_{CC} = 10.0 V$	-	-	35	-	-	-	ns/V

Table 5. **Recommended operating conditions**

Static characteristics 9.

R_{ON} resistance per switch for types 74HC4066 and 74HCT4066 Table 6.

 $V_I = V_{IH}$ or V_{IL} ; for test circuit see <u>Figure 6</u>.

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

Vos is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

For 74HC4066: V_{CC} – GND = 2.0 V, 4.5 V, 6.0 V and 9.0 V. For 74HCT4066: V_{CC} – GND = 4.5 V.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	1
R _{ON(peak)}	ON resistance (peak)	$V_{is} = V_{CC}$ to GND			•		1		
		V _{CC} = 2.0 V; I _{SW} = 100 μA	2]	-	-	-	-	-	Ω
		V_{CC} = 4.5 V; I _{SW} = 1000 µA		-	54	-	118	142	Ω
		V_{CC} = 6.0 V; I _{SW} = 1000 µA		-	42	-	105	126	Ω
		V_{CC} = 9.0 V; I _{SW} = 1000 µA		-	32	-	88	105	Ω
R _{ON(rail)}	ON resistance (rail)	V _{is} = GND							
		$V_{CC} = 2.0 \text{ V}; \text{ I}_{SW} = 100 \mu\text{A}$	2]	-	80	-	-	-	Ω
		V_{CC} = 4.5 V; I _{SW} = 1000 µA		-	35	-	95	115	Ω
		V_{CC} = 6.0 V; I _{SW} = 1000 µA		-	27	-	82	100	Ω
		V_{CC} = 9.0 V; I _{SW} = 1000 µA		-	20	-	70	85	Ω
		$V_{is} = V_{CC}$							
		$V_{\rm CC} = 2.0 \text{ V}; \text{ I}_{\rm SW} = 100 \mu\text{A}$	2]	-	100	-	-	-	Ω
		V_{CC} = 4.5 V; I _{SW} = 1000 μ A		-	42	-	106	128	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μA		-	35	-	94	113	Ω
		V_{CC} = 9.0 V; I_{SW} = 1000 μ A		-	20	-	78	95	Ω

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Table 6. R_{ON} resistance per switch for types 74HC4066 and 74HCT4066 ... continued

 $V_I = V_{IH}$ or V_{IL} ; for test circuit see <u>Figure 6</u>.

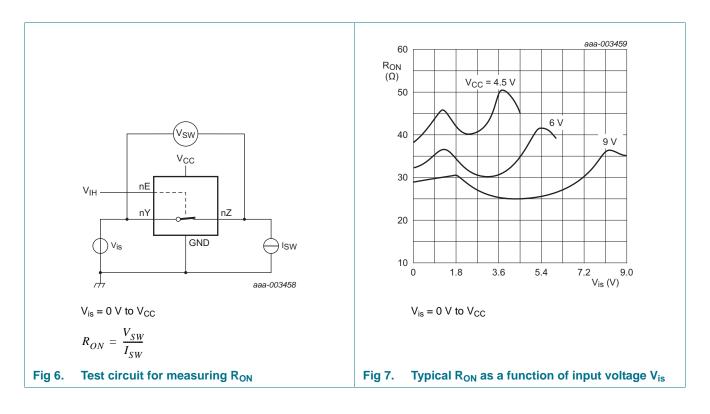
 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output. For 74HC4066: V_{CC} – GND = 2.0 V, 4.5 V, 6.0 V and 9.0 V.

For 74HCT4066: $V_{CC} - GND = 4.5 V.$

	Parameter	Conditions		–40 °C to +85 °C			–40 °C to	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
ΔR_{ON}	ON resistance	$V_{is} = V_{CC}$ to GND							
	mismatch between channels	$V_{CC} = 2.0 V$	[2]	-	-	-	-	-	Ω
	Charmers	$V_{CC} = 4.5 V$		-	5	-	-	-	Ω
		$V_{CC} = 6.0 V$		-	4	-	-	-	Ω
		$V_{CC} = 9.0 V$		-	3	-	-	-	Ω

[1] Typical values are measured at T_{amb} = 25 °C.

[2] At supply voltages (V_{CC} – GND) approaching 2 V, the analog switch ON resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital signals only, when using these supply voltages.



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Table 7. Static characteristics 74HC4066

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -40	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	1.2	-	V
		$V_{CC} = 4.5 V$	3.15	2.4	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	V
		$V_{CC} = 9.0 V$	6.3	4.7	-	V
VIL	LOW-level input voltage	$V_{CC} = 2.0 V$	-	0.8	0.5	V
		$V_{CC} = 4.5 V$	-	2.1	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.80	V
		$V_{CC} = 9.0 V$	-	4.3	2.70	V
I	input leakage current	$V_I = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	±1.0	μA
		V _{CC} = 10.0 V	-	-	±2.0	μΑ
S(OFF)	OFF-state leakage current	V_{CC} = 10.0 V; V_I = V_{IH} or V_{IL} ; $ V_{SW} = V_{CC} - GND$; see Figure 8				
		per channel	-	-	±1.0	μA
S(ON)	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; \text{ V}_{I} = V_{IH} \text{ or } \text{ V}_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 9}}{1000}$	-	-	±1.0	μΑ
СС	supply current	$V_I = V_{CC}$ or GND; $V_{is} =$ GND or V_{CC} ; $V_{os} = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	20.0	μA
		V _{CC} = 10.0 V	-	-	40.0	μA
CI	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance		-	8	-	pF
Γ _{amb} = -40	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		$V_{CC} = 4.5 V$	3.15	-	-	V
		$V_{CC} = 6.0 V$	4.2	-	-	V
		$V_{CC} = 9.0 V$	6.3	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.50	V
		$V_{CC} = 4.5 V$	-	-	1.35	V
		$V_{CC} = 6.0 V$	-	-	1.80	V
		V _{CC} = 9.0 V	-	-	2.70	V
I	input leakage current	$V_I = V_{CC}$ or GND				
		$V_{CC} = 6.0 V$	-	-	±1.0	μA
		V _{CC} = 10.0 V	-	-	±2.0	μA
S(OFF)	OFF-state leakage current	V_{CC} = 10.0 V; $V_I = V_{IH}$ or V_{IL} ; $ V_{SW} = V_{CC} - GND$; see Figure 8				
		per channel	-	-	±1.0	μA
S(ON)	ON-state leakage current	$V_{CC} = 10.0 \text{ V}; \text{ V}_{I} = V_{IH} \text{ or } \text{ V}_{IL};$ $ V_{SW} = V_{CC} - \text{GND}; \text{ see } \frac{\text{Figure 9}}{1000}$	-	-	±1.0	μΑ
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Table 7. Static characteristics 74HC4066 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

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Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{is} =$ GND or V_{CC} ; $V_{os} = V_{CC}$ or GND				
	supply current	$V_{CC} = 6.0 V$	-	-	40	μA
		V _{CC} = 10.0 V	-	-	80	μA

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

Table 8. Static characteristics 74HCT4066

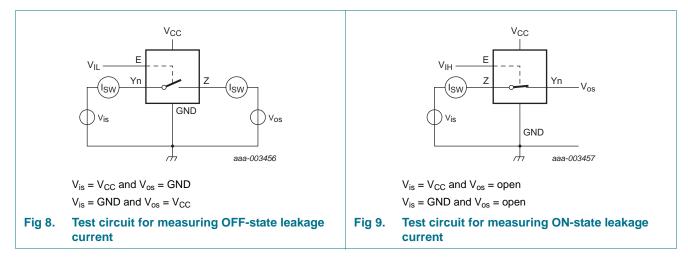
At recommended operating conditions; voltages are referenced to GND (ground = 0 V). V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -40	°C to +85 °C					
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	V
l _l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μA
$I_{S(OFF)}$	OFF-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } Figure 8$				
		per channel	-	-	±1.0	μA
I _{S(ON)}	ON-state leakage current		-	-	±1.0	μA
I _{CC}	supply current	$ V_I = V_{CC} \text{ or GND; } V_{is} = \text{GND or } V_{CC}; \\ V_{os} = V_{CC} \text{ or GND; } V_{CC} = 4.5 \text{ V to } 5.5 \text{ V} $	-	-	20.0	μA
ΔI_{CC}	additional supply current	per input pin; V _I = V _{CC} – 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V	-	100	450	μA
CI	input capacitance		-	3.5	-	pF
C _{sw}	switch capacitance		-	8	-	pF
T _{amb} = -40	°C to +125 °C					
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	V
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μA
I _{S(OFF)}	OFF-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } Figure 8$				
		per channel	-	-	±1.0	μA
I _{S(ON)}	ON-state leakage current	$V_{CC} = 5.5 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $ V_{SW} = V_{CC} - GND; \text{ see } Figure 9$	-	-	±1.0	μΑ
I _{CC}	supply current	$V_{1} = V_{CC} \text{ or GND}; V_{is} = GND \text{ or } V_{CC}; \qquad - \\ V_{os} = V_{CC} \text{ or GND}; V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-	40	μΑ
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1$ V; other inputs at V_{CC} or GND; $V_{CC} = 4.5$ V to 5.5 V	-	-	490	μΑ

[1] Typical values are measured at T_{amb} = 25 °C.

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10. Dynamic characteristics

Table 9. Dynamic characteristics 74HC4066

GND = 0 V; $t_r = t_f = 6$ ns; $C_L = 50$ pF unless specified otherwise; for test circuit see Figure 12.

 V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

Vos is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions		-4	0 °C to +85	S°C	–40 °C to	Unit	
			-	Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nY to nZ or nZ to nY; $R_L = \infty \Omega$; see <u>Figure 10</u>	[2]						
		$V_{CC} = 2.0 V$		-	8	75	-	90	ns
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
		$V_{CC} = 6.0 V$		-	2	13	-	15	ns
		$V_{CC} = 9.0 V$		-	2	10	-	12	ns
t _{off}	turn-off time	nE to nY or nZ; see Figure 11	<u>[4]</u>						
		$V_{CC} = 2.0 V$		-	44	190	-	225	ns
		$V_{CC} = 4.5 V$		-	16	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	13	-	-	-	ns
		$V_{CC} = 6.0 V$		-	13	33	-	38	ns
		$V_{CC} = 9.0 V$		-	16	26	-	30	ns
t _{on}	turn-on time	nE to nY or nZ; see Figure 11	<u>[3]</u>						
		$V_{CC} = 2.0 V$		-	36	125	-	150	ns
		$V_{CC} = 4.5 V$		-	13	25	-	30	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	11	-	-	-	ns
		$V_{CC} = 6.0 V$		-	10	21	-	26	ns
		V _{CC} = 9.0 V		-	8	16	-	20	ns
C _{PD}	power dissipation capacitance	per switch; $V_I = GND$ to V_{CC}	<u>[5]</u>	11		-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] t_{pd} is the same as t_{PHL} and t_{PLH} .

[3] t_{on} is the same as t_{PHZ} and t_{PLZ} .

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[4] t_{off} is the same as $t_{PZH and} t_{PZL}$.

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $\label{eq:PD} \mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_i + \textstyle \sum \{(\mathsf{C}_{\mathsf{L}} + \mathsf{C}_{\mathsf{sw}}) \times \mathsf{V}_{\mathsf{C}\mathsf{C}}^2 \times \mathsf{f}_o\} \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 $\Sigma\{(C_L + C_{sw}) \times V_{CC}{}^2 \times f_o\}$ = sum of outputs;

 C_L = output load capacitance in pF;

 C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

Table 10. Dynamic characteristics 74HCT4066

GND = 0 V; $t_r = t_f = 6$ ns; $C_L = 50$ pF unless specified otherwise; for test circuit see <u>Figure 12</u>. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input.

 V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions		-40	°C to +85	S°C	–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
t _{pd} propagation delay	nY to nZ or nZ to nY; $R_L = \infty \Omega$; see <u>Figure 10</u>	[2]						'	
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
t _{off}	turn-off time	nE to nY or nZ; see Figure 11	[4]						
		$V_{CC} = 4.5 V$		-	20	44	-	53	ns
		$V_{CC} = 5.0 \text{ V}; C_{L} = 15 \text{ pF}$		-	16	-	-	-	ns
t _{on}	turn-on time	nE to nY or nZ; see Figure 11	[3]						
		$V_{CC} = 4.5 V$		-	12	30	-	36	ns
		$V_{CC} = 5.0 \text{ V}; C_{L} = 15 \text{ pF}$		-	12	-	-	-	ns
C _{PD}	power dissipation capacitance	per switch; V _I = GND to (V _{CC} – 1.5 V)	<u>[5]</u>	-	12	-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$.

[2] t_{pd} is the same as t_{PHL} and t_{PLH} .

[3] t_{on} is the same as t_{PHZ} and t_{PLZ} .

[4] t_{off} is the same as $t_{PZH and} t_{PZL}$.

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum \{(C_L + C_{sw}) \times V_{CC}^2 \times f_o\}$ where:

 $f_i = input frequency in MHz;$

 $f_o =$ output frequency in MHz;

 $\sum \{ (C_L + C_{sw}) \times V_{CC}^2 \times f_0 \} = sum of outputs; \}$

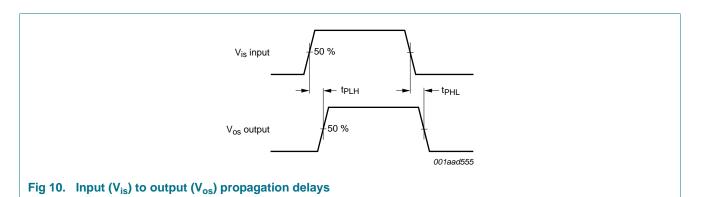
 C_L = output load capacitance in pF;

 C_{sw} = switch capacitance in pF;

 V_{CC} = supply voltage in V.

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11. Waveforms



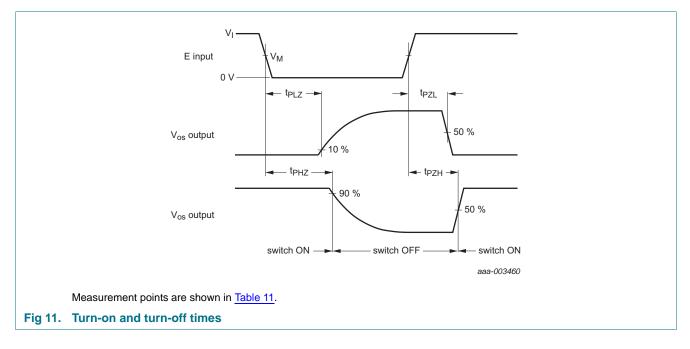


Table 11. Measurement points

Туре	VI	V _M
74HC4066	V _{CC}	0.5V _{CC}
74HCT4066	3.0 V	1.3 V

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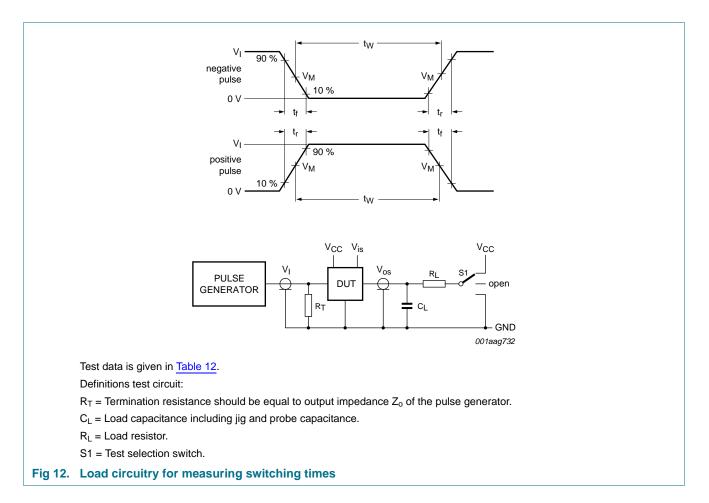


Table 12. Test data

Test	Input			Output		S1 position
	Control E	Control E Switch Yn (Z) t _r , t _r		Switch Z (Yn)	Switch Z (Yn)	
	V _I [1] V _{is}	V _{is}		CL	RL	
t _{PHL,} t _{PLH}	GND	GND to V _{CC}	6 ns	50 pF	-	open
t _{PHZ} , t _{PZH}	GND to $V_{\mbox{\scriptsize CC}}$	V _{CC}	6 ns	50 pF, 15 pF	1 kΩ	GND
t _{PLZ} , t _{PZL}	GND to V_{CC}	GND	6 ns	50 pF, 15 pF	1 kΩ	V _{CC}

[1] For 74HCT4066: maximum input voltage $V_I = 3.0 V$.

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12. Additional dynamic characteristics

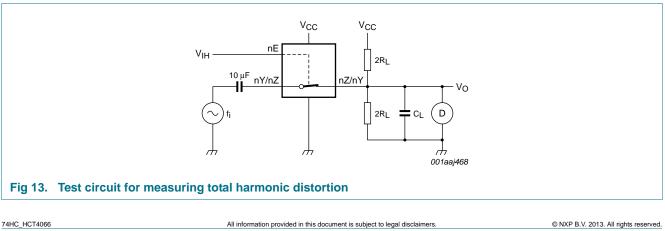
Table 13. Additional dynamic characteristics

Recommended conditions and typical values; GND = 0 V; $T_{amb} = 25 °C$. V_{is} is the input voltage at a Yn or Z terminal, whichever is assigned as an input. V_{os} is the output voltage at a Yn or Z terminal, whichever is assigned as an output.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD total harmonic distortion	total harmonic distortion	$f_i = 1 \text{ kHz}; R_L = 10 \text{ k}\Omega; C_L = 50 \text{ pF};$ see <u>Figure 13</u>				%
		V _{CC} = 4.5 V; V _I = 4.0 V (p-p)	-	0.04	-	%
		V _{CC} = 9.0 V; V _I = 8.0 V (p-p)	-	0.02	-	%
		$f_i = 10 \text{ kHz}; \text{ R}_L = 10 \text{ k}\Omega; \text{ C}_L = 50 \text{ pF};$ see Figure 13				
		V _{CC} = 4.5 V; V _I = 4.0 V (p-p)	-	0.12	-	%
		V _{CC} = 9.0 V; V _I = 8.0 V (p-p)	-	0.06	-	%
$f_{(-3dB)}$ –3 dB free	-3 dB frequency response	$R_L = 50 \Omega$; $C_L = 10 pF$; see Figure 15	[2]			
		$V_{CC} = 4.5 V$	-	180	-	MHz
		V _{CC} = 9.0 V	-	200	-	MHz
α_{iso} isolation	isolation (OFF-state)	R_L = 600 Ω ; C_L = 50 pF; f _i = 1 MHz; see <u>Figure 14</u>	[1]			
		$V_{CC} = 4.5 V$	-	-50	-	dB
		V _{CC} = 9.0 V	-	-50	-	dB
V _{ct} crosstalk vo	crosstalk voltage	between digital input and switch (peak to peak value); $R_L = 600 \Omega$; $C_L = 50 pF$; $f_i = 1 MHz$; see Figure 16				
		$V_{CC} = 4.5 V$	-	110	-	mV
		$V_{CC} = 9.0 V$	-	220	-	mV
Xtalk	crosstalk	between switches; R_L = 600 Ω ; C_L = 50 pF; f _i = 1 MHz; see Figure 17	[1]			
		V _{CC} = 4.5 V	-	-60	-	dB
		$V_{CC} = 9.0 V$	-	-60	-	dB

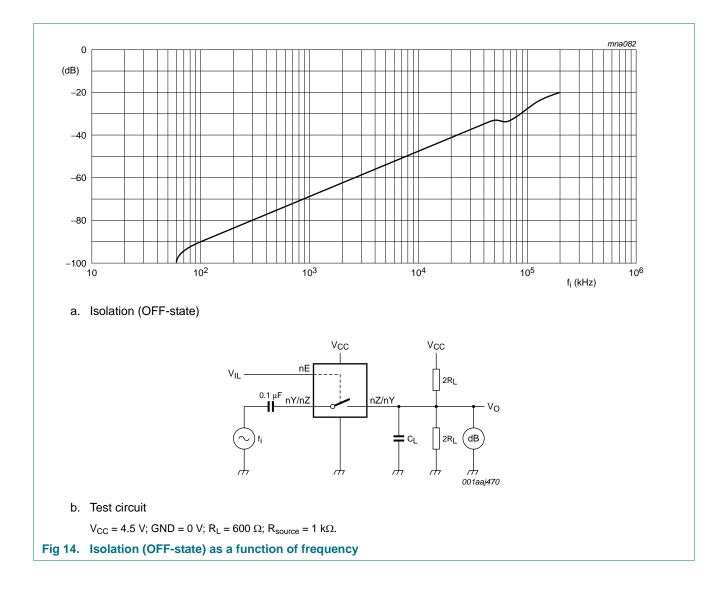
[1] Adjust input voltage V_{is} to 0 dBm level (0 dBm = 1 mW into 600 Ω).

[2] Adjust input voltage V_{is} to 0 dBm level at V_{os} for $f_i = 1$ MHz (0 dBm = 1 mW into 50 Ω). After set-up, f_i is increased to obtain a reading of -3 dB at V_{os}.



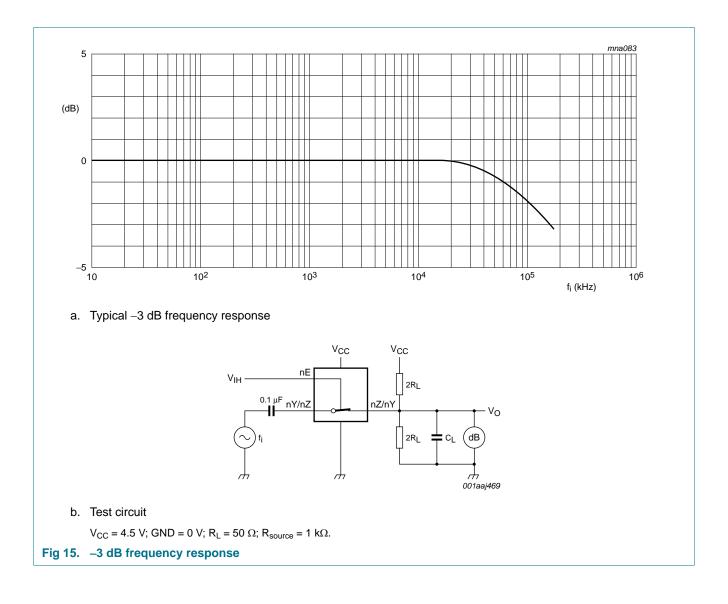
74HC4066; 74HCT4066

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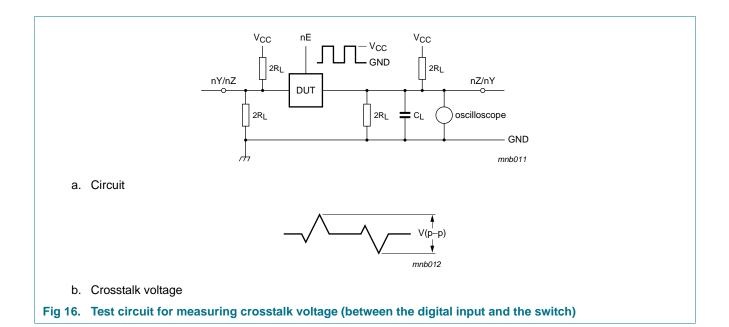
74HC4066; 74HCT4066

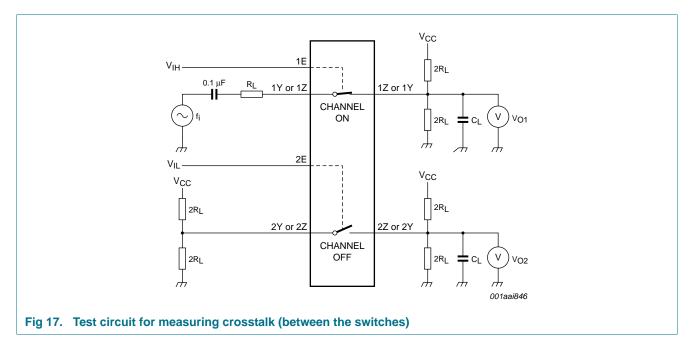
Quad single-pole single-throw analog switch



74HC4066; 74HCT4066

Quad single-pole single-throw analog switch





Quad single-pole single-throw analog switch

13. Package outline

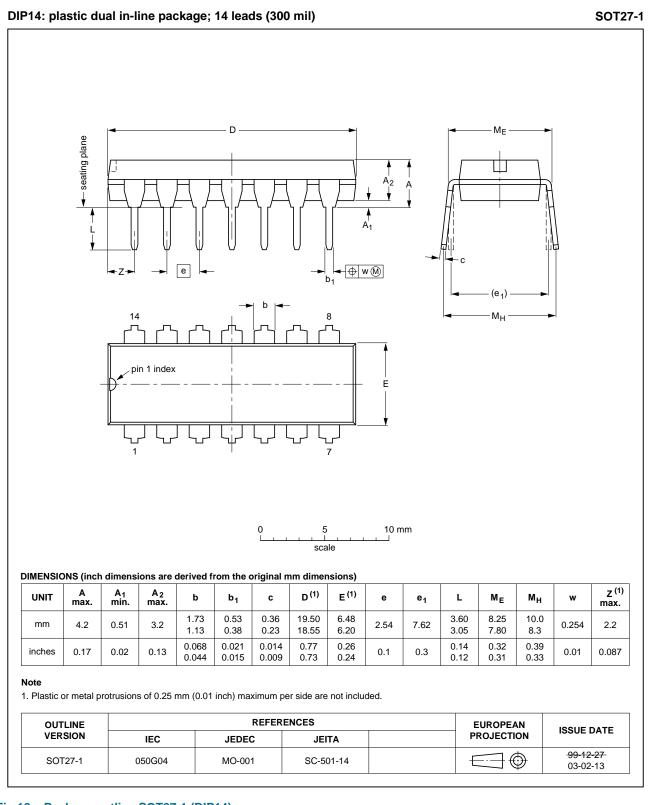


Fig 18. Package outline SOT27-1 (DIP14)

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Quad single-pole single-throw analog switch

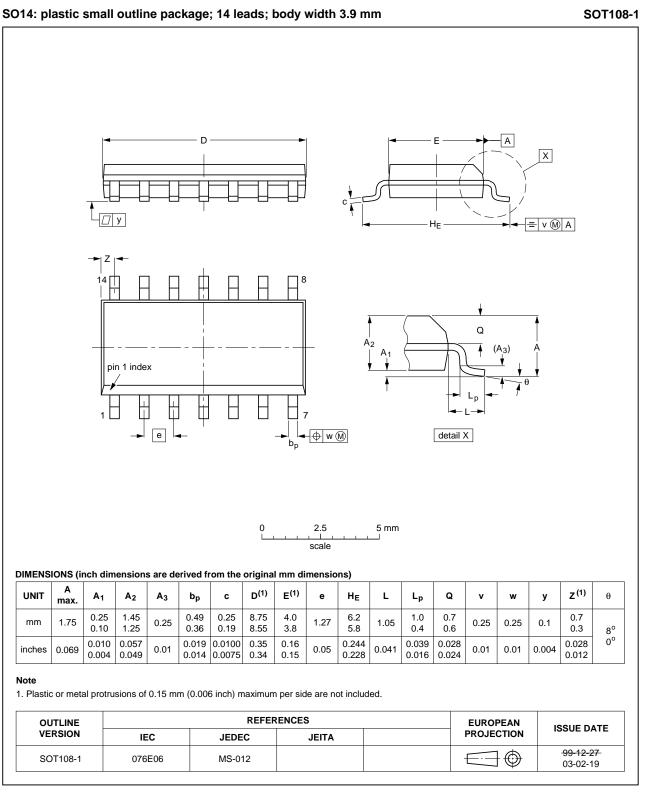


Fig 19. Package outline SOT108-1 (SO14)

Quad single-pole single-throw analog switch

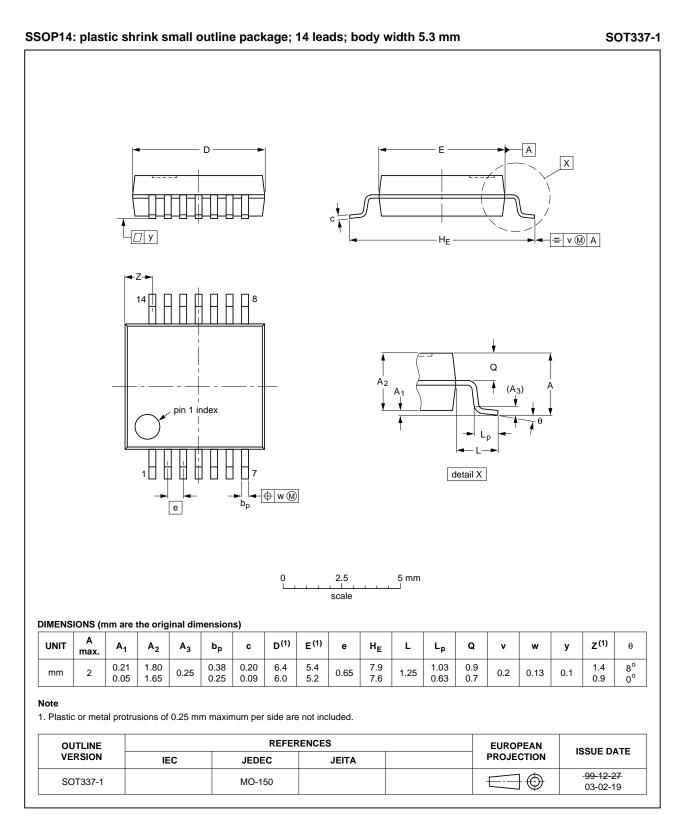


Fig 20. Package outline SOT337-1 (SSOP14)

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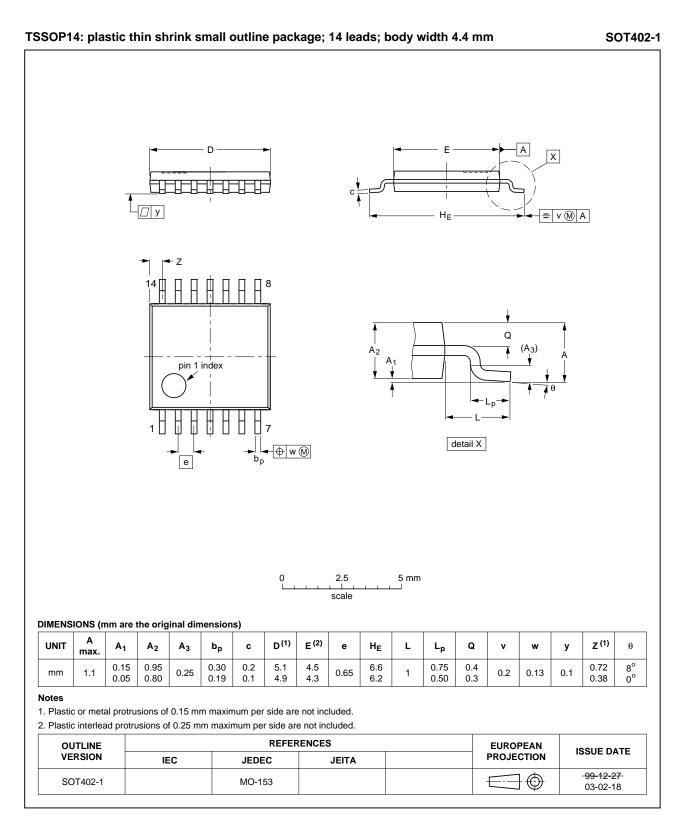
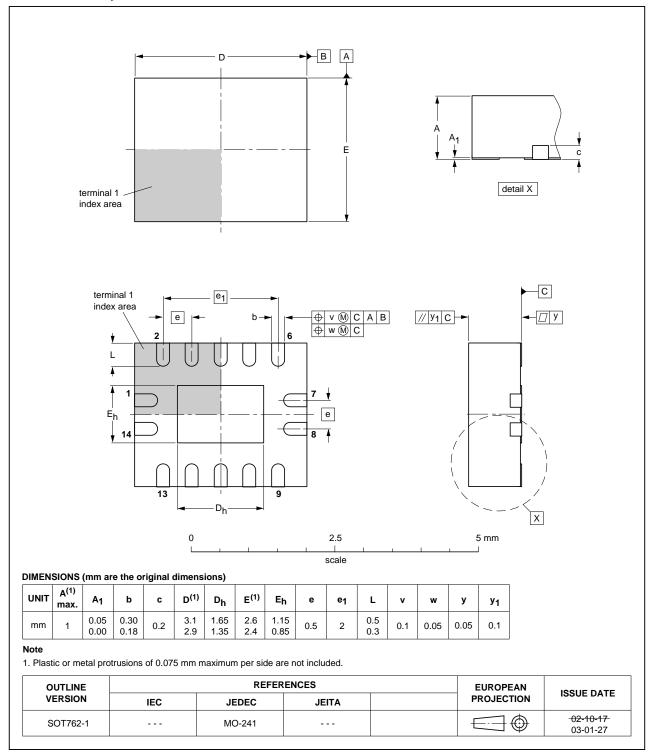


Fig 21. Package outline SOT402-1 (TSSOP14)

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Quad single-pole single-throw analog switch



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 22. Package outline SOT762-1 (DHVQFN14)

Quad single-pole single-throw analog switch

14. Abbreviations

Table 14. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			

15. Revision history

Table 15.Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4066 v.7	20130402	Product data sheet	-	74HC_HCT4066 v.6
Modifications:	 Descriptive ti 	tle corrected (errata).		
	 New general 	description (errata).		
74HC_HCT4066 v.6	20120718	Product data sheet	-	74HC_HCT4066 v.5
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 			
	 Legal texts have 	ave been adapted to the new o	company name wher	e appropriate.
74HC_HCT4066 v.5	20041111	Product data sheet	-	74HC_HCT4066 v.4
74HC_HCT4066 v.4	20030617	Product data sheet	-	74HC_HCT4066_CNV v.3
74HC_HCT4067_CNV v.3	19981110	Product data sheet	-	74HC_HCT4066_CNV v.2
74HC_HCT4066_CNV v.2	19981002	Product specification	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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